

FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

Title of Invention	[SEMICONDUCTOR PACKAGE MODULE AND MANUFACTURING MEHOD THEREOF]			
Application Number :				
Date :				
First Named Applicant:	Mr. SHIH-CHANG LEE			
Attorney Docket Number:	9249-US-PA			
TOTAL FEE AUTHORIZED \$ 862				
Patent fees are subject to annual revisions on or about October 1st of each year.				
Filing as large entity				
BASIC FILING FEE				
Fee Description	Fee Code	Amount \$	Fee Paid \$	
Utility Filing Fee	1001	750	750	
Subtotal For Basic Filing Fees: \$ 750				
EXTRA CLAIM FEES				
Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 24	4	1202	18	72
Independent Claims : 2	0	1201	84	0
Subtotal For Extra Claims Fees: \$ 72				
ASSIGNMENT FEES				
Fee Description	Property Number	Quantity	Fee Code	Amount \$
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	40
Subtotal For Additional Fees: \$40				
AUTHORIZED BILLING INFORMATION				
The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:				
Credit account number:	1007			
Expiration Date (YYYYMMDD):	2005-12-31			
Authorized name:	YEH, WEN-HUNG			
Billing address:	99999			